

Microsemi. Silicon Sculptor **Quick Reference Card**

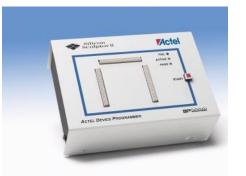
Introduction

Thank you for purchasing Microsemi® Silicon Sculptor programming system. This system enables field programming of Microsemi field programmable gate arrays (FPGAs) for proof of concept up to the largest production runs. Microsemi also offers programming services through its factory and distribution partners to meet a variety of custom requirements.

There is little margin for error in today's competitive world, so Microsemi has assembled the following quick reference guide to help you maximize programming yield. The patented antifuse architecture of Microsemi is the most secure programmable logic platform available today. As this innovative technology is One Time Programmable, it is not possible for Microsemi to screen out 100% of potential programming failures. As a result, a small percentage of each lot is lost in the standard programming process, but there are ways to minimize the fallout.

By following a few easy guidelines, you can prevent unnecessary programming failures and improve overall yields. This document provides guidelines for pre-programming setup, programming both antifuse and Flash FPGAs, how to manage programming failures, a list of common error messages, and troubleshooting tips.

This guide was designed as a reference to keep near your programming station and use as a training guide for programming operators. Details about the Silicon Sculptor and its software may be found in the Silicon Sculptor User's Guide at: www.microsemi.com/soc.



Pre-Programming Setup

The following steps are required before programming Microsemi devices with Silicon Sculptor:

Use Proper Handling and ESD Precautions Microsemi FPGAs are sensitive electronic devices that are susceptible to damage from ESD and other types of mishandling. You can find specific handling instructions for several packages at: www.microsemi.com/soc/techdocs/package/default.aspx#mfg.

Use the Latest Version of the Silicon Sculptor Software The programming software is frequently updated in order to accommodate yield enhancements in FPGA manufacturing. These updates ensure maximum programming yield and minimum programming times. Before programming, always check that the version of the Silicon Sculptor software you are using is the most recent: www.microsemi.com/soc/custsup/updates/silisculpt/.

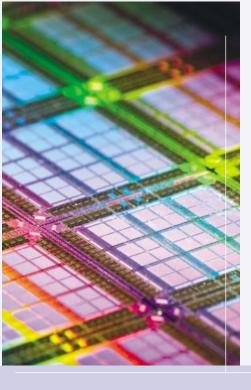
Use the Latest Version of the Designer Software to Generate Your Programming File (Recommended) The files that are used to program (.afm, .fus, .bit, .stp) contain important information about the fuses and switches that are programmed in the FPGA. Always zip the programming files to avoid corruption of programming file during file transfer. Find the latest version and corresponding release notes at: www.microsemi.com/soc/custsup/updates/designer/index.html.

Use the Most Recent Adapter Module Occasionally, Microsemi makes modifications to these modules to improve programming yields and programming times. To identify the latest version of each module before programming, visit: www.microsemi.com/soc/products/hardware/program_debug/ss/modules.aspx.

Perform Routine Hardware Self-Diagnostic The self-diagnostic verifies correct operation of the pin drivers, power supply, CPU, memory, and adapter module. This test should be performed before every programming session. As a minimum, the test must be executed every week. For RH/RT devices you must run self-test before programming each device.

To execute the self-diagnostic on Windows versions: Click on Device, select Actel Diagnostic, select the Test tab, click OK.

Perform Routine Hardware Verification and Calibration The verification and calibration procedure verifies that the test limits used during the self-diagnostic are accurate. Verification and calibration of the Silicon Sculptor is required every 12 months for all devices (except RH/RT). For RadHard and RadTolerant devices, you must perform this before programming every programming session. For verification and calibration instructions, refer: www.microsemi.com/soc/documents/SiliSculptProgCali UG.pdf



Programming Failure Guidelines

Even though it is impossible for Microsemi to screen out 100% of potential programming failures on antifuse FPGAs, we do screen for low programming yields by programming a sample of devices from every lot that we ship. The size of this sample is selected to give us a high level of confidence that we satisfy the 97% to 100% yield criteria for most antifuse devices.

As long as all the requirements listed above and on the previous page are satisfied, Microsemi replaces 100% of field programming rejects. If the programming yield is lower than expected, Microsemi performs an investigation to determine if the high failure rate is caused by the system used to program the devices or can be attributed to the devices themselves.

On the other hand, the Flash FPGAs are reprogrammable, so Microsemi tests the programmability for 100% of the devices shipped and expected fallout is zero.

Note: For Programming Failure Allowance Tables refer to the "Programming and Functional Failure Guidelines" document.

Continued on inside panel



Programming Antifuse FPGAs

The following steps are required to program Microsemi Antifuse FPGAs

Perform Blankcheck (Recommended) This test confirms that the actual device you are about to program matches the device selected and is completely blank. This helps to prevent mixing up programming failures with blank devices. We recommend performing this before each programming session.

Program This is the step where the actual programming file is mapped into the device. Don't forget to enable programming the security fuses if desired. If broadcasting, press Start to program each site.

Checksum (Recommended) This step confirms that the FPGA has been programmed correctly.

Save the log file Programming log is saved under C:\BP|DATALOG folder. For every programming session a separate file is created. Always have a copy of the file saved for your record. This log file is required to submit Tech Support case for programming failures.

FAQs for Programming Microsemi Antifuse FPGA

Microsemi recommends you to check the following FAQs for any concerns or questions you have on Programming Antifuse FPGAs: www.microsemi.com/soc/documents/AFprogrammingFAQ.pdf

Programming Flash FPGAs

The following steps are required to program Microsemi Flash FPGAs

Program Programming a Flash device is a one step process whether you are programming using a socket adapter module or using the ISP module (ProASIC and ProASIC Plus devices only) with a cable to your board. The Execute function automatically erases the device, programs the Flash cells, and verifies that it is programmed correctly. Microsemi recommends that you confirm the security status is correct before programming.

Antifuse FPGAs (non RH/RT)

1. Debug the Error Message

Any Time You Encounter a Failure:

- Record the EXACT error message
- Compare your error message to those listed in the "Common Programming Failure Modes" table, and try to resolve the problem based on the given suggestions.

If failures continue, proceed to the next step.



2. Check the Programming Setup

- Record the version of the Silicon Sculptor software being used, then upgrade to the latest version: www.microsemi.com/soc/custsup/updates/silisculpt
- Perform the self-diagnostic
- Record the exact part number of the adapter module(s) being used, then upgrade to the latest version: www.microsemi.com/soc/products/hardware/program_debug/ss/modules.aspx

Continue programming and proceed to the next step.



3. Check the Programming Yield

Compare your programming fallout with the "<u>Programming Failure</u> <u>Allowance Table</u>" located to the right. As long as you are within the guidelines, continue programming. Contact your distributor or sales office to return devices, and provide failure rates along with your request.

If the failure rate exceeds expected fallout, proceed to the next step.



4. Record Device Details

Record the following for all failures and programmed devices:

- Date code (4 digit number on top of device)
- Lot code (alphanumeric usually on underside of device)
- Number failed and number passed programming from each lot



RadHard and RadTolerant FPGAs

1. Debug the Error Message and Check the Programming Setup

Stop Programming Immediately.

Due to the high cost of RH/RT devices, it is important that you ensure your software and hardware are up to date and are in good working condition. It is also important that you provide detailed information about the failure to Microsemi. Refer to the "RH/RT Programming Guide" and "RTAX-S/SL/DSP Programming Guide" application note on Microsemi website for more detailed information about programming RH and RT devices.

- Record the EXACT error message
- Save the .txt file under a different name, so it is not overwritten
- Perform the self-diagnostic
- Record the version of the Silicon Sculptor software being used, then upgrade to the latest version:

www.microsemi.com/soc/custsup/updates/silisculp

 Record the exact part number of the programming module(s) being used, then upgrade to the latest version:

If failures continue, proceed to the next step.



2. Check the Programming Yield

Compare your programming fallout with the <u>"Programming Failure Allowance Table"</u> located to the right. As long as you are within the guidelines, continue programming. Contact your distributor or sales office to return devices, and provide ALL of the above information with your request.

If the failure rate exceeds expected fallout, proceed to the next step.



3. Record Device Details

Record the following for all failures and programmed devices:

- Date code (4 digit number on top of device)
- Lot code (alphanumeric usually on underside of device)
- Serial number (top of device)
- Number failed and number passed programming from each Lot



Flash FPGAs

1. Debug the Error Message

Even though Microsemi tests the programmability of every Flash FPGA, there are several external factors that can cause devices to fail, especially when performing In-System Programming, such as noise and out-of date software and programming hardware. Review the application notes on Microsemi website for details on ISP:

www.microsemi.com/soc/techdocs/appnotes/default.aspx

For all failures:

- Record the EXACT error message
- Record the operation being executed when error occurs
- Compare your error message to those listed in this table, and try to resolve the problem based on the suggestions given.

If failures continue, proceed to the next step.



2. Check the Programming Setup

- Record the version of the Silicon Sculptor software being used, then
 upgrade to the latest version:
 www.microsemi.com/soc/custsup/updates/silisculpt
- Perform the self-diagnostic
- Record the exact part number of the programming module(s) being used, then upgrade to the latest version:
 www.microsemi.com/soc/documents/FA Policies Guidelines 5-06-00002.pdf

If failures continue, proceed to the next step.

3. Record Device Details

Record the following for all failures and programmed devices:

- Date code (4 digit number on top of device)
- Lot code (alphanumeric usually on underside of device)
- Number failed and number passed programming from each lot



Contact Microsemi Support

Contact Microsemi Support with the Results of the Above Diagnostics Including:

Antifuse

- Programming FA checklist (http://www.microsemi.com/soc/documents/Programming Failure Analysis Checklist Antifuse.zip)
- Programming log files (C:\BP\DATALOG)
- Afm and adb files
- Specific Error Messages Obtained
- The .log File

RH/RT

- Programming FA checklist
 (http://www.microsemi.com/soc/documents/Programming_Failure
 Analysis Checklist Antifuse.zip)
- Programming log files: (C:\BP\DATALOG)
- Afm and adb files
- Software Versions Used
- Adapter Module Part Number

Flash

- Programming FA checklist (http://www.microsemi.com/soc/ documents/Programming Failure Analysis Checklist Flash.zip)
- Programming log files (C:\BP\DATALOG)
- Stp and adb files

Note

For Programming Failure Allowance Tables refer to the "Programming and Functional Failure
Guidelines" document.

Common Programming Failure Modes

Note (RH/RT only): Before programming any additional RH/RT devices, first complete steps 1 and 2 of the previous page.

Error	Probable Cause	Resolution
	The chip may be damaged.	Try to program another device.
Invalid Electronic Signature in Chip (Device ID)	The chip is not in the proper position in the programmer site.	Reseat the device to ensure that it is oriented correctly in the socket and is making good contact with the socket.
	The socket is dirty and not making a connection.	Clean the socket and make sure that it is making good contact with the device.
Device is Not Blank	The device was previously programmed and cannot be erased.	The Device/Blank command was executed or the "Blank check before programming" option was enabled in the Device/Options dialog box, and the device in the programmer site is determined to have programmed data.
	The wrong algorithm was used.	Make sure that the device and package selected in the software exactly matches the device being programmed.
Incorrect Checksum	Previous programming is done on device with different programming file.	Make sure the AFM file used to perform the Microsemi_Checksum command is the AFM file used to program the device.
	The checksum fuses were not programmed correctly.	The programmer has reported that the checksum antifuses could not be programmed. Record the actual and reported checksum values, and continue following the guidelines for handling programming failures.
Failed to Program Fuse XXX Pulse YYY	There is a problem programming this particular antifuse.	The programmer has reported that this antifuse cannot be programmed. Record the fuse and pulse numbers, and continue following the guidelines for handling programming failures.
	AFM programming file corruption.	It may be due to improper file transfer (always zip the programming file before transferring).
Failed Current Sense	The standby current has increased significantly after programming.	The programmer has reported that the device cannot be reliably programmed. Record the error message, and continue following the guidelines for handling programming failures.
Failed Fuse XXX, Integrity Test YYY	The programmer has reported that this device cannot be correctly programmed.	XXX indicates the fuse number failed. YYY indicates the test number. Record the fuse and integrity test numbers, and continue following the guidelines for handling programming failures.
Excessive Current Detected. The Protection Circuit Has Shut Off the Power	The command was aborted to protect the programmer and the device. The device was taking too much current from the programmer.	Reseat the device to ensure that it is oriented correctly in the socket and is making good contact with the socket.
	The wrong algorithm could be selected and improper voltages were applied to the chip in the programmer site.	Select the correct device and package in the Silicon Sculptor software, and make sure you are using the latest version of the programming software.
	There could be a short in the programming adapter.	Perform the self-diagnostic with the module on the programmer, and try another module if available.
	The device is damaged.	Remove the chip and run the self-diagnostic to make sure all the pin drivers are functioning correctly. If the hardware passes the test, be sure you have the correct algorithm (device entry) selected for your device. If the error still occurs and you are sure the device is inserted correctly, then the problem may be a faulty device.
Error in Programming Algorithm	The software has detected an internal error.	Download the latest Silicon Sculptor software and try again.
There is No Data in the Buffer. You Must Load a File	A command tried to read data from the buffer to program or verify a chip, but nothing has been loaded into the buffer yet or the buffer was recently cleared.	Open the programming file you wish to use in the Silicon Sculptor software.
	AFM programming file corruption.	It may be due to improper file transfer (always zip the programming file before transferring)

Common Programming Failure Modes (continued)

Error	Probable Cause	Resolution
There is No Chip in the Programmer Site	A defective chip may cause this error.	Try programming another device.
	The chip may not be inserted correctly.	Reseat the device to ensure that it is oriented correctly in the socket and is making good contact with the socket.
	Programming hardware or module may be faulty.	Remove the device and run the hardware self-diagnostic with and without the adapter module.
Sorry, Algorithm Not Found. Call Technical Support	The .EXE file you are executing has been corrupted.	Download the latest version of the programming software. If error persists, Microsemi examines this on a case by case basis. Contact Microsemi technical support.
You Must Properly Install the Correct Socket Module	There is no socket module installed.	Install the correct adapter module.
	The adapter module installed does not support the device you have selected (e.g. you have selected a 100 pin device and you have a 208 pin PQFP socket module attached).	Check the Microsemi website for the correct part number to use with your device and package. Make sure that you are using the latest revision (i.e. "-1" or "-2" as listed on the website).
	The socket module installed is not supported by the version of the software you are using.	Make sure you are using the latest version of the Silicon Sculptor programming software.
Device Already Secured	The device cannot be legitimately programmed because it has been secured.	The only function that can be performed on a secured device is the checksum command (this does not work for all families). There is nothing else that you can do with a secured device. For Flash FPGAs, you must have the security code to reprogram the device.
Hardware Requires Calibration. Call Technical Support.	The self-diagnostic (Alt-D) has detected that the hardware is improperly calibrated.	The unit may need to be returned for repair
Self-Diagnostic Failed. This Unit May Need Service. Call Technical Support	The self-diagnostic (Alt-D) has detected a hardware problem.	The unit may need to be returned for repair

Note: For all technical inquiries regarding programming, contact Microsemi technical support: **Email:** soc_tech@microsemi.com/ / **Phone:** 800.262.1060



Microsemi Corporate Headquarters One Enterprise, Aliso Viejo CA 92656 USA Within the USA: +1 (949) 380-6100 Sales: +1 (949) 380-6136 Fax: +1 (949) 215-4996 Microsemi Corporation (NASDAQ: MSCC) offers a comprehensive portfolio of semiconductor solutions for: aerospace, defense and security; enterprise and communications; and industrial and alternative energy markets. Products include high-performance, high-reliability analog and RF devices, mixed signal and RF integrated circuits, customizable SoCs, FPGAs, and complete subsystems. Microsemi is headquartered in Aliso Viejo, Calif. Learn more at www.microsemi.com.

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